



# Ai-WB2-01S Specification

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## **Document resume**

Version	Date	Develop/revise content	Edition	Approve
V1.0.0	2022.9.1	First Edition	Jingran Xiao	NingGuan



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## **1. Product Overview**

Ai-WB2-01S is a Wi-Fi & BLE module developed by Shenzhen Ai-Thinker Technology Co., Ltd. This module is equipped with BL602 chip as the core processor and supports Wi-Fi 802.11b/g/n protocol and BLE 5.0 protocol. The BL602 chip has a built-in 32-bit RISC CPU with low power consumption and 276KB RAM. It can be widely used in Internet of Things (IoT), mobile devices, wearable electronic devices, smart home and other fields.

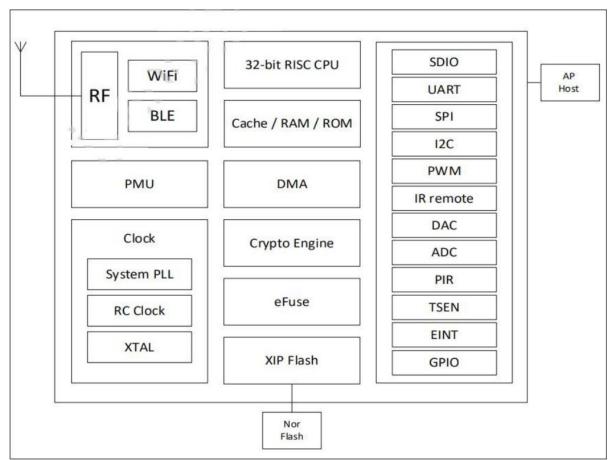


Figure 1 architecture of main chip



#### 1.1. Characteristic

- DIP-8 package
- Supports IEEE 802.11 B/g/n protocol
- Wi-Fi security supports WPS/WEP/WPA/WPA2 Personal/WPA2 Enterprise/WPA3
- Supports 20MHz bandwidth with a maximum speed of 72.2 Mbps.
- Bluetooth 5.0, Bluetooth Mesh
- Supports Station + BLE mode, Station + SoftAP + BLE mode
- Supports 32-bit RISC CPU and 276KB RAM
- Secure Startup, supports Images with ECC-256 signatures
- Supports real-time AES decryption (OTFAD) in QSPI and SPI Flash, and supports AES 128 CTR mode
- Supports AES 128, 192, and 256-bit encryption engines
- Supports SHA-1/224/256
- Support True Random Number Generator (TRNG)
- Public Key Accelerator (PKA), support large number basic operations, software provides signature, verification and other application program interface
- Supports UART,PWM,ADC, and GPIO
- Integrated Wi-Fi MAC/BB/RF/PA/LNA/BT
- Supports multiple sleep modes with a deep sleep current of 12µA
- Universal AT instruction for quick start
- Supports secondary development and integrates Windows and Linux development environments



## 2. Main parameters

#### Table 1 main parameters

Model	Ai-WB2-01S				
Package	DIP-8				
Size	14.5*24.5*11.2(±0.2)mm				
Antenna	on-board PCB antenna				
Frequency	2400 ~ 2483.5MHz				
Operating temperature	-40°C ~ 85°C				
Storage temperature	-40°C ~ 125°C, < 90%RH				
Power supply	Power supply voltage $2.7V \sim 3.6V$ , power supply current $\geq 500 \text{mA}$				
Interface	UART/GPIO/ADC/PWM				
ΙΟ	3				
UART rate	Default value: 115200 bps				
Security	WPS/WEP/WPA/WPA2 Personal/WPA2 Enterprise/WPA3				
Flash	Default 2MByte Support expansion				

## 2.1. Static electricity requirement

Ai-WB2-01S are electrostatic sensitive equipment, special precautions should be taken during handling.



Figure 2 ESD anti-static diagram



#### 2.2. Electrical characteristics

#### Table 2 Electrical Characteristics Table

Parameter		Conditio	Minimum	Typical value	Maximum	Com
Supply voltage		VDD	2.7	3.3	3.6	V
VIL		-	-	-	0.3*VDDIO	V
I/O	VIH	-	0.7*VDDIO	-	-	V
	VOL	-	-	0.1*VDDIO	-	V
	VOH	-	-	0.9*VDDIO	-	V
	IMAX	-	-	-	15	mA

## 2.3. Wi-Fi RF performance

#### Table 3 Wi-Fi RF performance table

Description		Typical value							
Frequency range	24	$2400 \sim 2483.5 MHz$							
Output power									
Mode	Min.	Typical value	Max.	Unit					
11n mode HT20, PA output power	_	16	-	dBm					
11g mode, PA output power	-	17	-	dBm					
11b mode, PA output power	-	-	dBm						
]	Receiving sens	sitivity							
Mode Min. Typical value Max.									
11b, 1 Mbps	-	-98	-	dBm					
11b, 11 Mbps	-	-90	-	dBm					
11g, 6 Mbps	-	-93	-	dBm					
11g, 54 Mbps	-	-76	-	dBm					
11n, HT20 (MCS7)	-	-73	-	dBm					



#### 2.4. BLE RF performance

Description		Unit					
Frequency range	24	2400 ~ 2483.5MHz					
Output power							
Rate Mode	Min.	Typical value	Max.	Unit			
1Mbps	-	15	dBm				
Receiving sensitivity							
Rate Mode	Min.	Typical value	Max.	Unit			
1Mbps sensitivity @ 30.8% PER	-	-96	-	dBm			

#### Table 4 BLE RF performance table

#### 2.5. Power

The following power consumption data is based on a 3.3V power supply, 25°C ambient temperature, and measured using an internal regulator

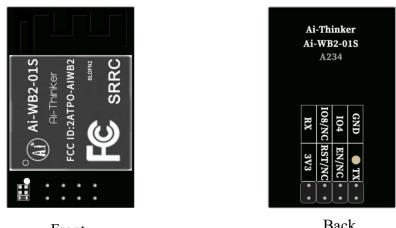
- All measurements are made at the antenna interface with a filter.
- All transmission data are based on 100% duty cycle in continuous transmission mode

#### Table 5 Power Consumption Table

Mode	Min.	Average	Max.	Comp
Tx 802.11b, 11Mbps, POUT=+21dBm	-	320	-	mA
Tx 802.11g, 54Mbps, POUT =+18dBm	-	269	-	mA
Tx 802.11n, MCS7, POUT =+16dBm	_	240	-	mA
Rx 802.11b, packet length 1024 byte	-	63	-	mA
Rx 802.11g, packet length 1024 byte	_	63	-	mA
Rx 802.11n, Packet length 1024 byte	-	63	-	mA
Deep-Sleep	-	12	-	μΑ



## 3. Appearance size



Front

Back

#### Figure 3 External view (for reference only)

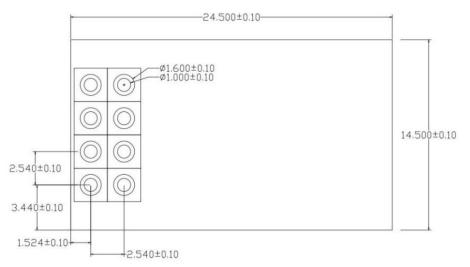


Figure 4 Dimension diagram (unit: mm)



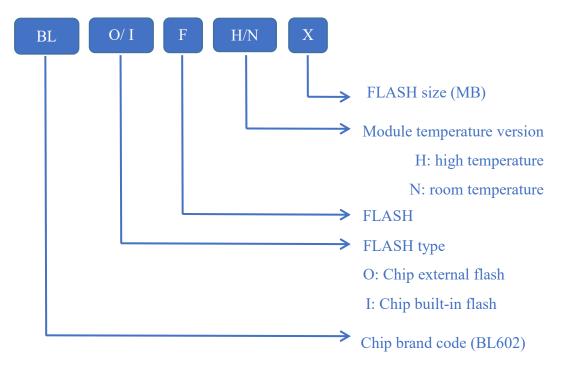
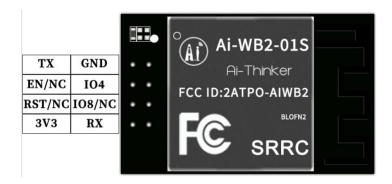


Figure 5 the representative information of screen printing of Shield

## 4. Pin definition

Ai-WB2-01S module is connected with a total of 8 pins, as shown in the pin schematic diagram, pin function definition table is the interface definition.



Front

#### Figure 6 pin diagram



#### **Table 6 Definition table of pin functions**

No.	Name	Description
1	GND	Ground
2	IO4	GPIO4/SPI_MOSI/MISO/IIC_SCL/PWM_CH4/ADC_CH4
3	IO8/NC	NC, unavailable. If you need to use it, please contact Ai-Thinker. Bootstrap/GPIO8/SPI_MOSI/MISO/IIC_SCL/PWM_CH3
4	RX	RXD/GPIO7/SPI_SCLK/IIC_SDA/PWM_CH2
5	TX	TXD/GPIO16/SPI_MOSI/MISO/IIC_SCL/PWM_CH1
6	EN/NC	By default, it is enabled as a chip and is effective at a high level
7	RST/NC	The default NC is unavailable
8	3V3	3.3V power supply. It is recommended that the output current of the external power supply be higher than 500mA
Note:		·

1.At the moment of power-on, if Bootstrap GPIO8 is high, the module enters the programming mode; if Bootstrap GPIO8 is low, the module starts normally.



## 5. Schematic

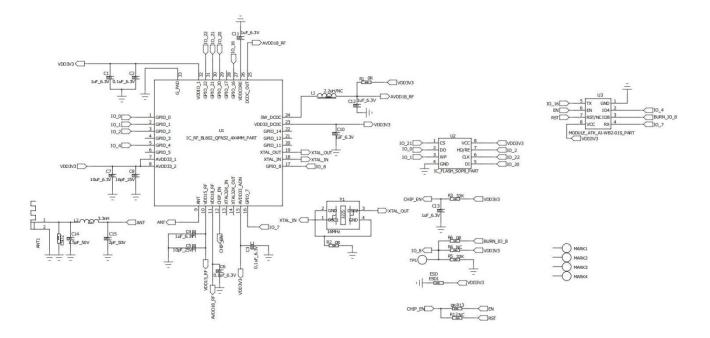


Figure 7 schematic diagram



## 6. Antenna parameters

## 6.1. Antenna Test prototype



Figure 8 antenna Test prototype sketch Map



#### 6.2. Antenna S parameters

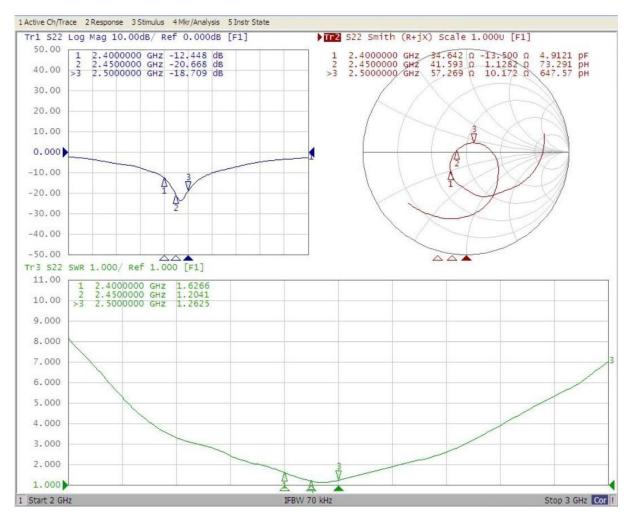


Figure 9 antenna S parameters

#### 6.3. Antenna gain and efficiency

#### Table 7 antenna gain and efficiency

Frequency ID	1	2	3	4	5	6	7	8	9	10	11
Frequency(MHz)	2400	2410	2420	2430	2440	2450	2460	2470	2480	2490	2500
Gain (dBi)	0.22	0.46	0.84	1.21	1.39	1.61	1.71	1.72	1.67	1.70	1.84
Efficiency (%)	41.43	42.58	44.95	47.63	49.55	53.10	54.63	55.26	55.00	54.57	54.22



## 6.4. Antenna pattern

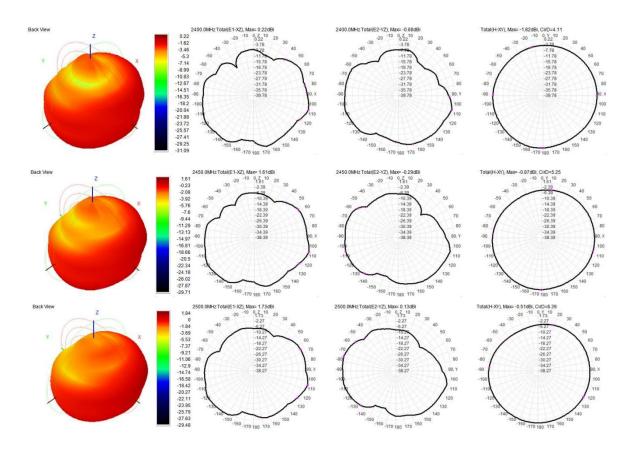


Figure 10 Antenna pattern



## 7. Design Guidance

#### 7.1. Application Guide circuit

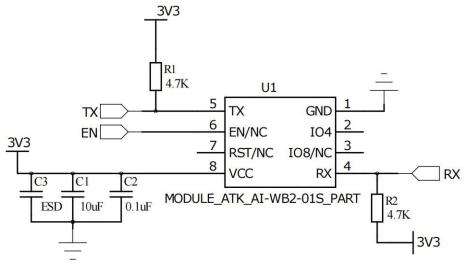
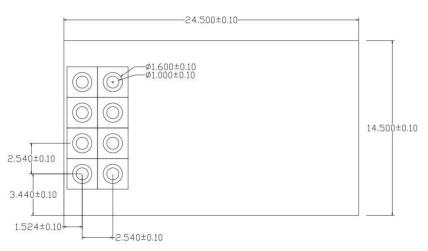


Figure 11 Application circuit diagram

- If the IO port is used as PWM, it is recommended to reserve a 4.7K pull-down resistor around the module. Especially in the application of light control, it can prevent the flashing light phenomenon at the moment of power-on start
- The IO8/NC, RST/NC, which are not available by default. If you need to use it, please contact Ai-Thinker

#### 7.2. Recommend PCB package size



#### Figure 12 recommended PCB package size (unit: mm)

■ Recommended 2.54mm 2\*4 row needle base



#### 7.3. Antenna layout requirements

■ The installation position on the motherboard is recommended in the following two ways:

Option 1: put the module on the edge of the motherboard, and the antenna area extends out of the edge of the motherboard

Option : put the module on the edge of the motherboard, the edge of the motherboard at the antenna position hollowed out an area

In order to meet the performance of onboard antenna, it is forbidden to place metal parts around the antenna and keep away from high frequency devices

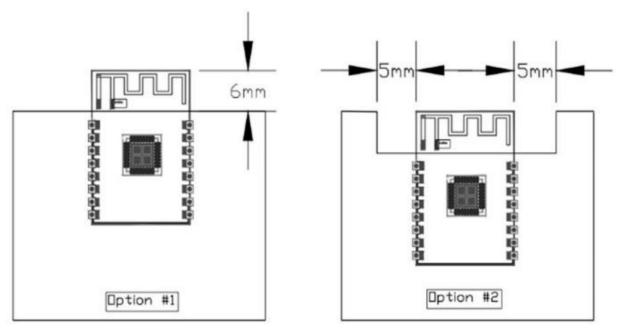


Figure 13 Antenna layout diagram



#### 7.4. Power supply

- Recommended 3.3V voltage, peak current over 500mA.
- We recommend that you use LDO for power supply. If you use DC-DC, we recommend that you control the ripple within 30mV.
- DC-DC power supply circuit is recommended to reserve the position of dynamic response capacitance, which can optimize the output ripple when the load changes greatly.
- It is recommended to add ESD devices to the 3.3V power interface.

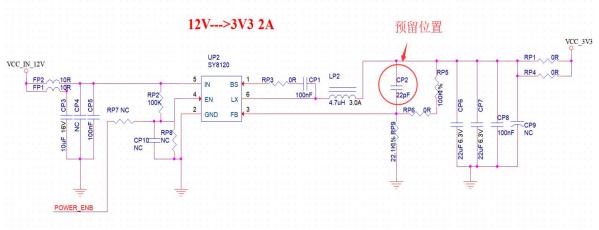
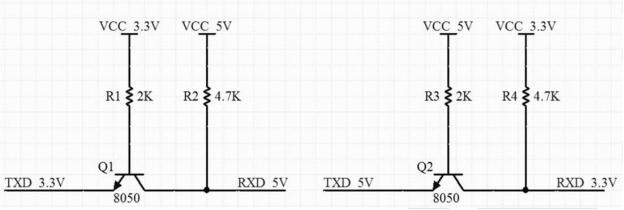


Figure 14 DC-DC step-down circuit diagram



#### 7.5. GPIO

- There are some IO ports on the periphery of the module. If you need to use it, it is recommended to connect a 10-100 ohm resistor in series with the IO port. This inhibits overshoot and makes both sides level more stable. It is helpful for EMI and ESD.
- For special I/O ports to be pulled up and down, refer to the direction for use in the specifications, which may affect the module start-up configuration.
- The I/O port of the module is 3.3V. If the main control does not match the I/O port level of the module, a level conversion circuit needs to be added.
- If the I/O port is directly connected to the peripheral interface, or the terminal such as the row pin, it is recommended to reserve ESD devices near the terminal of the I/O port.



**Figure 15 level conversion circuit** 



## 8. Storage Conditions

Products sealed in moisture-proof bags shall be stored in a non-condensing atmospheric environment of <40°C/90% RH.

The humidity sensitivity level MSL of the module is Level 3.

After the vacuum bag is unpacked, it must be used up within 168 hours at 25±5°C/60%RH, otherwise it can be put on line again after baking.

#### (0°) 道 通 峰值温度 235 ~ 250°C 250 回流区 预热恒温区 冷却区 -1 ~ -5°C/s 150 ~ 200°C 60 ~ 120s >217°C 60~90s 217 200 焊接时间 > 30s 升温区 ~ 3°C/s 100 50 25 时间 (s) 0 100 150 200 250 50 0 升温区 - 温度: 25~150°C 时间: 60~90s 升温斜率: 1~3°C/s 预热恒温区 - 温度: 150~200°C 时间: 60~120s 回流焊接区 - 温度: >217°C 时间: 60~90s; 峰值温度: 235~250°C 时间: 30~70s 冷却区 — 温度: 峰值温度~180°C 降温斜率-1~-5°C/s 焊料 - 锡银铜合金无铅焊料 (SAC305)

## 9. Reflow welding curve diagram

Figure 16 reflow soldering curve



## **10.Product packaging information**

Ai-WB2-01S module was packaged in a tape, 200pcs/reel. As shown in the below image:



Figure 17 Package and packing diagram

## **11.Contact us**

Ai-Thinker official website

Office forum

Develop DOCS

LinkedIn\_

Taobao shop

Alibaba shop

Technical support email: support@aithinker.com

Domestic business cooperation: sales@aithinker.com

Overseas business cooperation: overseas@aithinker.com

Tmall shop

Company Address: Room 403,408-410, Block C, Huafeng Smart Innovation Port, Gushu 2nd Road, Xixiang, Baoan District, Shenzhen.

Tel: +86-0755-29162996



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